## Yuya Hattori

Yuki Tokumoto and Keiichi Edagawa

Institute of Industrial Science, The University of Tokyo, 4-6-1, Komaba, Meguro-ku, Tokyo, Japan

E-mail: <u>yhattori@iis.u-tokyo.ac.jp</u>

# Electrical properties of Pb(Bi,Sb)<sub>2</sub>Te<sub>4</sub> topological insulators

Topological insulators (TIs) are known to exhibit characteristic 2D surface states similar to graphene and other Dirac materials. TIs' surface states are spin-polarized, and immune to scattering at impurities. These unique properties make TIs promising materials for future applications as novel spintronic devices [1] for sustainable society. However, the detection and practical use of the surface states are currently a bit difficult. The reason is that the bulk bandgap is narrow in most of the TIs identified so far (Figure 1a), and characteristic surface conduction is masked by bulk conduction [2]. Therefore, many efforts have been made to improve bulk insulation in this field. In our research, we chose Pb(Bi,Sb)<sub>2</sub>Te<sub>4</sub> TI, which has twice higher density of surface carriers than ordinary BSTS-TI [3]. By changing Bi/Sb ratio precisely, we succeeded in obtaining bulk insulating samples for the first time in this system, and resistivity value at T=2K was about 100 higher than previous research [4]. Remaining bulk conduction was considered to be contributed by impurity bands in the bulk band gap [5]. Magnetoresistance observed in this system was quite well interpreted as 3D-WAL scheme [5]. We then proceeded to investigate surface states using such high resistivity samples.

Total conduction in TIs should be the sum of bulk and surface contributions [6] (2-channel model, Figure 1b). Equivalent circuit is also shown. Then, total resistance R and resistivity  $\rho_{xx}$  can be expressed by surface resistivity  $\rho_s$ , bulk resistivity  $\rho_b$ , surface thickness  $t_s$ , bulk thickness  $t_b$ , sample length l and sample width w, as follows.

$$R = \frac{1}{\frac{1}{R_{s}} + \frac{1}{R_{b}}} = \frac{1}{\frac{wt_{s}}{\rho_{s}l} + \frac{wt_{b}}{\rho_{b}l}} = \frac{\rho_{s}\rho_{b}l}{(t_{s}\rho_{b} + t_{b}\rho_{s})\cdot w}$$
(1)  

$$\rho_{xx} = \frac{(t_{b} + t_{s})w}{l}R = \frac{\rho_{s}\rho_{b}(t_{b} + t_{s})}{t_{s}\rho_{b} + t_{b}\rho_{s}} = \frac{\rho_{s}(1 + t_{s}/t_{b})}{t_{s}/t_{b} + \rho_{s}/\rho_{b}}$$
(2)

Here,  $t_b$  can be changed by sample thickness and  $t_s$  is constant (about 5nm [6]). In the limit of  $t_s/t_b \rightarrow 0$  (thick sample), then  $\rho_{xx} \rightarrow \rho_b$ , and if  $t_s/t_b \rightarrow \infty$  (thin samples),  $\rho_{xx} \rightarrow \rho_s$ . So, by reducing thickness, surface conduction can be made dominant. AFM image of typical device is shown in Figure 1c. Sample thickness is  $t = t_s + t_b = 190nm$ , and other size factors can be measured by AFM data. The temperature dependence of resistivity measured in nano-flake is shown in Figure 1d (blue line). The resistivity at T=2K is  $\rho_{xx} = 25.3 \text{ m}\Omega\text{cm}$ , considerably lower than thick sample with  $\rho_b = 164\text{m}\Omega\text{cm}$ . Therefore, this can be attributed to surface conductance.  $\rho_s$  can be calculated by eq. (2) and its value is  $\rho_s = 0.78 \text{ m}\Omega\text{cm}$ . In BSTS-series TI, the reported  $\rho_s$  is about 2.2 m $\Omega$ cm [6], so surface conductivity is higher in our samples. As surface electrons  $n_s$  of Pb(Bi,Sb)<sub>2</sub>Te<sub>4</sub> is reported to be twice as many as that of BSTS, lower  $\rho_s = \sigma_s^{-1} = (qn_s\mu_s)^{-1}$  can be attributed to higher surface carrier density. In addition, the contribution of surface conduction to total conduction is about 85% in thin flakes(190nm), while 0.5% in thick samples(200 $\mu$ m). If quantum oscillation originating from surface states can be detected, more quantitative analysis of surface properties, such as surface carrier density,  $n_s$  fermi wavenumber  $k_F$ , mobility  $\mu_s$ , etc., can be conducted

#### References

- [1] A. R. Mellnik et al., *Nature*, **511**, 449 (2014).
- [2] Z. Ren et al., Phys. Rev. B, 82, 241306 (2010).

- [3] K. Kuroda et al., *Phys. Rev. Lett.*, **108**, 206803 (2012).
- [4] L. Pan et al., J. Solid State Chem., 225,168 (2015).
- [5] Y. Hattori et al., *Phys. Rev. Materials*, **1**, 074201 (2017).
- [6] B. Xia et al., *Phys. Rev. B*, **87**, 085442 (2013).

### **Figures**



#### Figure 1:

- (a) Schematic picture of Pb(Bi,Sb)2Te4's band structure (BS). Bulk and surface states have different BS.
- (b) schematic picture of transport channels in TIs.
- In order to reduce bulk contribution, efforts have been made to enhance bulk resistivity and reduce bulk thickness tb
- (c) AFM image of typical device for electrical measurements. Sample is in the center, and Au probe is contacted.
- (d) Temperature dependence of resistivity of nano-flake(blue) and bulk(red) sample. Resistivity significantly reduces when reducing sample thickness.